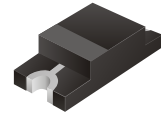


CDBS00340

$I_o = 30\text{mA}$
 $V_R = 40\text{Volts}$



Features

- Designed for mounting on small surface
- Extremely thin package
- Low stored charge
- Majority carrier conduction

Mechanical data

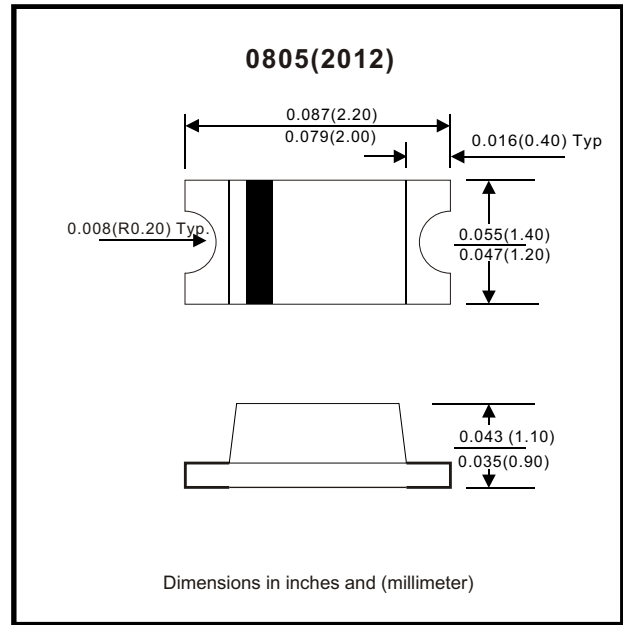
Case: 0805(2012) Standard package, molded plastic.

Terminals: Solder plated, solderable per MIL-STD-750, method 2026.

Polarity: Indicated by cathode band.

Mounting position: Any.

Weight: 0.0048 gram. (approximately)



Maximum Rating (at $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Repetitive peak reverse voltage		V_{RRM}			45	V
Reverse voltage		V_R			40	V
Average forward current		I_o			30	mA
Forward current , surge peak	8.3 ms single half sine-wave superimposed on rate load (JEDEC method)	I_{FSM}		500		mA
Power Dissipation		P_D			200	mW
Storage temperature		T_{STG}	-40		+125	$^\circ\text{C}$
Junction temperature		T_j	-40		+125	$^\circ\text{C}$

Electrical Characteristics (at $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Forward voltage	$I_F = 1\text{ mA DC}$	V_F			0.37	V
Reverse current	$V_R = 40\text{ V}$	I_R			1	μA
Reverse current	$V_R = 30\text{ V}$	I_R			0.5	μA
Capacitance between terminals	$f = 1\text{ MHz}$, and 1 VDC reverse voltage	C_T		2		pF

RATING AND CHARACTERISTIC CURVES (CDBS00340)

Fig. 1 - Forward characteristics

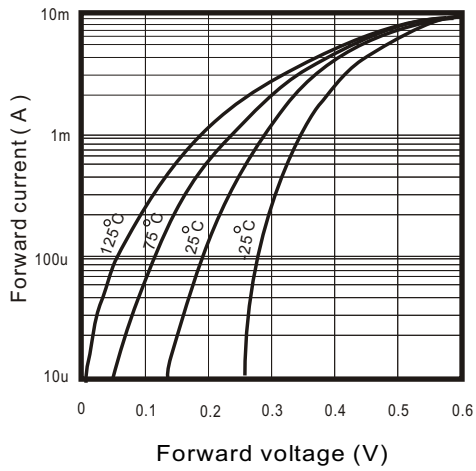


Fig. 1 - Forward characteristics

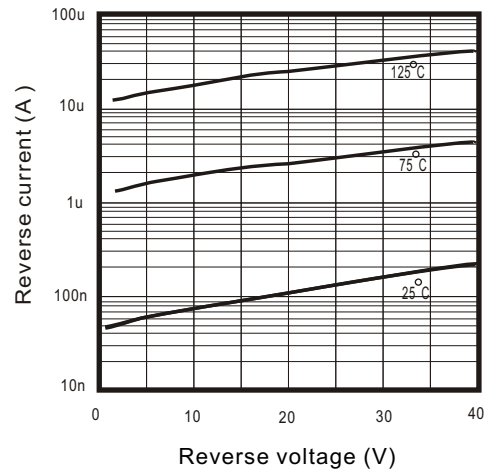


Fig. 3 - Capacitance between terminals characteristics

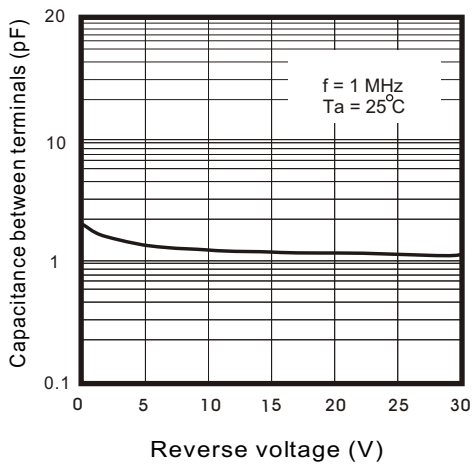


Fig. 4 - Current derating curve

